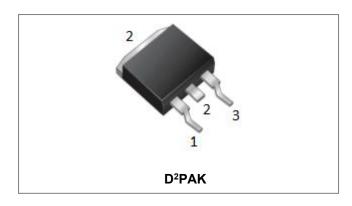


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## MBRB20150CT SCHOTTKY RECTIFIER



### **Features**

- 150°C T<sub>J</sub> operation
- Center tap configuration
- · Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

# **Circuit Diagram**



### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

## **Maximum Ratings:**

| Characteristics  | Symbol   | Condition                                       | Max.                          | Units |
|--|--|---|-------------------------------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | $egin{array}{c} V_{RRM} \ V_{RWM} \ \end{array}$ | -   | 150                           | V     |
| Average Rectified Forward Current (Per Device)                                   | I <sub>F (AV)</sub>                              | 50% duty cycle @Tc=100°C, rectangular wave form | 10(Per Leg)<br>20(Per Device) | Α     |
| Peak One Cycle Non-Repetitive Surge Current(Per Leg)                             | I <sub>FSM</sub>                                 | 8.3ms, Half Sine pulse                          | 150                           | Α     |

### **Electrical Characteristics:**

| Characteristics               | Symbol          | Condition   | Тур.  | Max.   | Units |
|-------------------------------|-----------------|---|-------|--------|-------|
| Forward Voltage Drop          | V <sub>F1</sub> | @ 10A, Pulse, T <sub>J</sub> = 25 °C                            | 0.84  | 0.90   | V     |
| (Per Leg) *                   | V <sub>F2</sub> | @ 10A, Pulse, T <sub>J</sub> = 125 °C                           | 0.75  | 0.80   | V     |
| Reverse Current (Per Leg) *   | I <sub>R1</sub> | @V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 25 °C | 0.001 | 1      | mA    |
|                               | I <sub>R2</sub> | $@V_R = \text{rated } V_{R_s} T_J = 125 ^{\circ}\text{C}$       | 0.1   | 6.0    | mA    |
| Junction Capacitance(Per Leg) | Ст              | $@V_R = 5V, T_C = 25  ^{\circ}C, f_{SIG} = 1MHz$                | 170   | 400    | pF    |
| Series Inductance(Per Leg)    | Ls              | Measured lead to lead 5 mm from package body                    | 8.0   | -      | nH    |
| Voltage Rate of Change        | dv/dt           | -   | -     | 10,000 | V/μs  |

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

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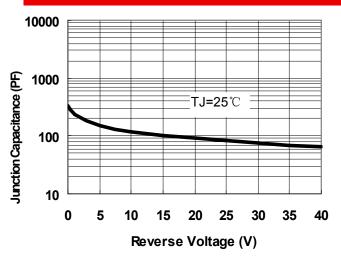




## **Thermal-Mechanical Specifications:**

| Characteristics                                      | Symbol             | Condition    | Specification | Units |
|--|--------------------|--------------|---------------|-------|
| Junction Temperature                                 | TJ                 | -            | -55 to +150   | °C    |
| Storage Temperature                                  | T <sub>stg</sub>   | -            | -55 to +150   | °C    |
| Typical Thermal Resistance Junction to Case(Per Leg) | R <sub>θ</sub> JC  | DC operation | 3.5           | °C/W  |
| Approximate Weight                                   | wt                 | -            | 1.85          | g     |
| Case Style   | D <sup>2</sup> PAK |              |               |       |

## **Ratings and Characteristics Curves**



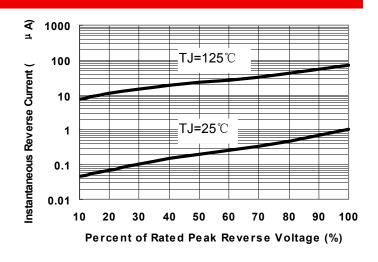


Fig.1-Typical Junction Capacitance

Fig.2-Typical Reverse Characteristics

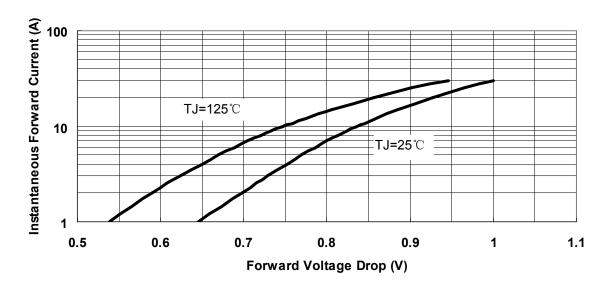


Fig.3-Typical Instantaneous Forward Voltage Characteristics

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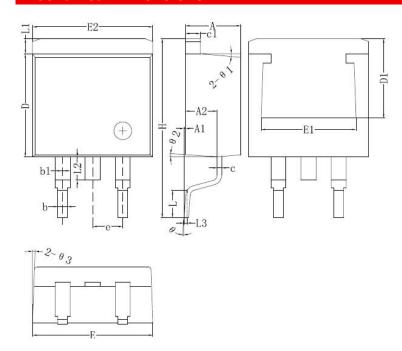


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## Mechanical Dimensions D<sup>2</sup>PAK



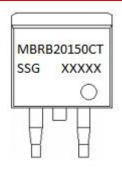
| Symbol | Dimensions in millimeters |         |       |
|--------|---------------------------|---------|-------|
|        | Min.                      | Typical | Max.  |
| Α      | 4.47                      | 4.70    | 4.85  |
| A1     | 0                         | 0.10    | 0.25  |
| A2     | 2.59                      | 2.69    | 2.89  |
| b      | 0.71                      | 0.81    | 0.96  |
| b1     | 1.17                      | 1.27    | 1.37  |
| С      | 0.31                      | 0.38    | 0.61  |
| c1     | 1.17                      | 1.27    | 1.37  |
| D      | 8.50                      | 8.70    | 8.90  |
| D1     | 6.40                      |         |       |
| E      | 10.01                     | 10.16   | 10.31 |
| E1     | 7.6                       |         |       |
| E2     | 9.98                      | 10.08   | 10.31 |
| е      |                           | 2.54    |       |
| Н      | 14.6                      | 15.1    | 15.6  |
| L      | 2.00                      | 2.30    | 2.74  |
| L1     | 1.12                      | 1.27    | 1.42  |
| L2     | 1.30                      |         | 2.20  |
| L3     |                           | 0.25BSC |       |
| е      | 0                         | -       | 8°    |
| e1     |                           | 5°      |       |
| e2     |                           | 4°      |       |
| e3     |                           | 4°      |       |

## **Ordering Information**

| Device      | Package            | Shipping      |
|-------------|--------------------|---------------|
| MBRB20150CT | D <sup>2</sup> PAK | 800pcs / reel |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## **Marking Diagram**



Where XXXXX is YYWWL

 MBR
 = Device Type

 B
 = Package type

 20
 = Forward Current (20A)

 150
 = Reverse Voltage(150V)

 CT
 = Configuration

 SSG
 = SSG

 YY
 = Year

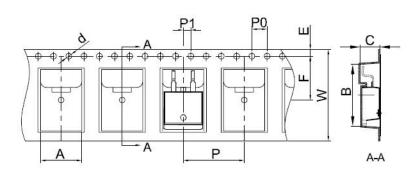
 WW
 = Week

= Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

## Carrier Tape Specification D<sup>2</sup>PAK



| SYMBOL  | Millimeters |       |  |
|---------|-------------|-------|--|
| STWIDUL | Min.        | Max.  |  |
| Α       | 10.70       | 10.90 |  |
| В       | 16.03       | 16.23 |  |
| С       | 5.11        | 5.31  |  |
| d       | 1.45        | 1.65  |  |
| E       | 1.65        | 1.85  |  |
| F       | 11.40       | 11.60 |  |
| P0      | 3.90        | 4.10  |  |
| Р       | 15.90       | 16.10 |  |
| P1      | 1.90        | 2.10  |  |
| W       | 23.90       | 24.30 |  |

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#### **MBRB20150CT**



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